HMC320MS8G

LOW NOISE AMPLIFIER 5.0 - 6.0 GHz

FEBRUARY 2001 v00.0900

Features

Selectable Functionality:
LNA, Driver, or LO Buffer Amp

Adjustable Input IP3
Up To +10 dBm

+3V Operation

Ultra Small 8 Lead MSOP:
14.8 mm² x 1mm High

General Description

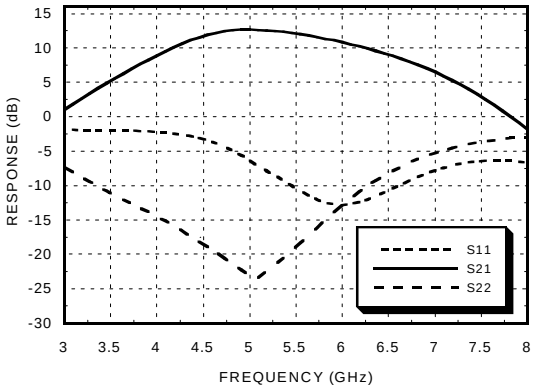
The HMC320MS8G is a low cost C-band fixed gain Low Noise Amplifier (LNA) that serves the full UNII and HiperLAN bands. The HMC320MS8G operates using a single positive supply that can be set between +3V and +5V. With +3V bias, the LNA provides a noise figure of 2.5 dB, 12 dB gain and better than 10 dB return loss across the UNII band. The HMC320MS8G also features adaptive biasing that allows the user to select the optimal P1dB performance for their system using an external set resistor on the "RES" pin. P1dB performance can be set between a range of +1 dBm to +13 dBm. The low cost LNA uses an 8-leaded MSOP ground base surface mount plastic package, which occupies less than 14.8mm².

Guaranteed Performance, *Vdd = +3V, -40 to +85 deg C*

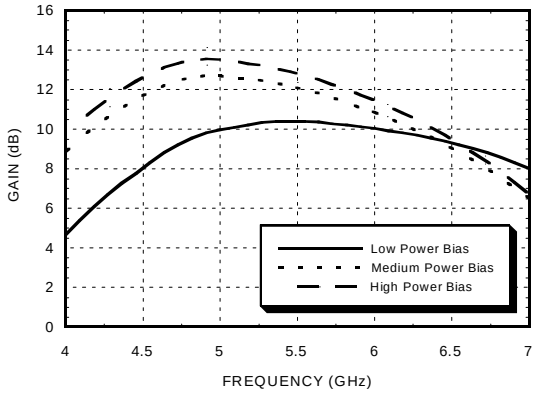
Parameter	Low Power* (VSET= 0V, Idd= 7mA)			Medium Power* (VSET= 3V, Idd= 25mA)			High Power* (VSET= 3V, Idd= 40mA)			
	Min.	Typ.	Max.	Min.	Typ.	Max.	Min.	Typ.	Max.	Units
Frequency Range		5 - 6			5 - 6			5 - 6		GHz
Gain @25° C	8	10	16	8	12	16	9	13	16	dB
Gain Variation over Temp		0.025	0.035		0.025	0.035		0.025	0.035	dB/ °C
Gain Flatness		± 0.5			± 1.0			± 1.5		dB
Noise Figure		2.7	3.8		2.5	3.8		2.6	3.8	dB
Input Return Loss	4	10		4	10		4	10		dB
Output Return Loss	7	13		10	18		10	20		dB
Output 1 dB Compression Point (P1dB)	- 4	- 1		6	9		9	12		dBm
Input Third Order Intercept Point (IIP3)	- 3	1		4	8		6	10		dBm
Recommended Supply Voltage (Vdd)	2.75	3.0	3.25	2.75	3.0	3.25	2.75	3.0	3.25	Vdc
Supply Current (Idd)		7			25			40		mA

* RBIAS resistor value sets current. See adaptive biasing application note.

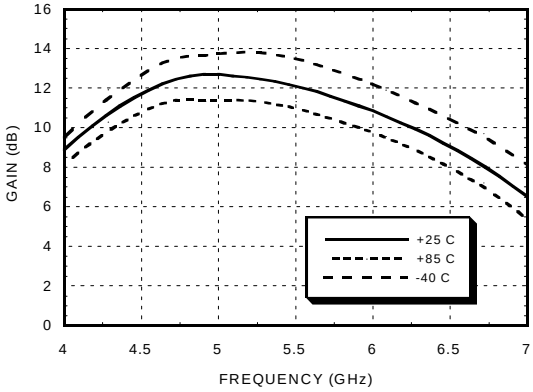
Broadband Gain & Return Loss Medium Power Bias



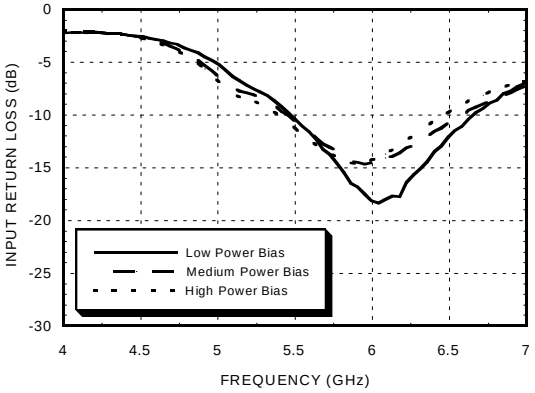
Gain @ Three Bias Conditions



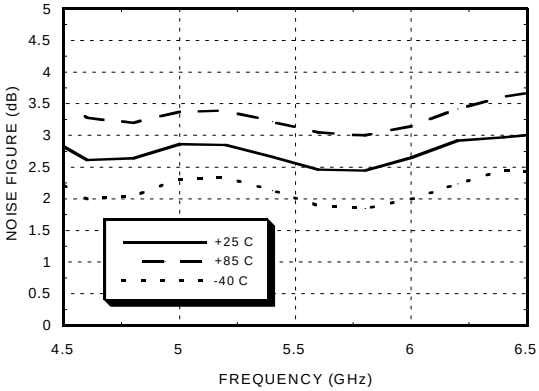
Gain vs. Temperature Medium Power Bias



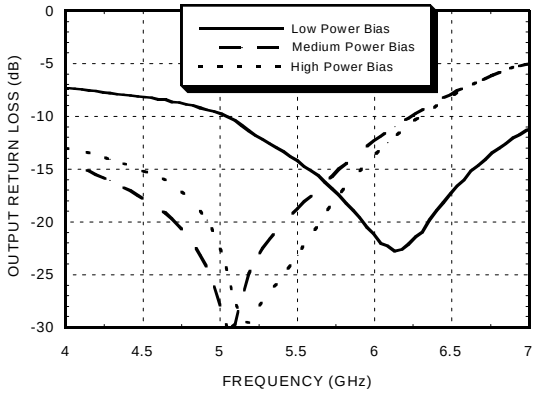
Input Return Loss @ Three Bias Conditions



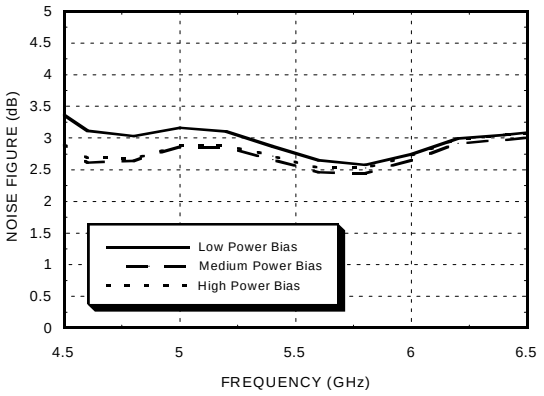
Noise Figure vs. Temperature Medium Power Bias



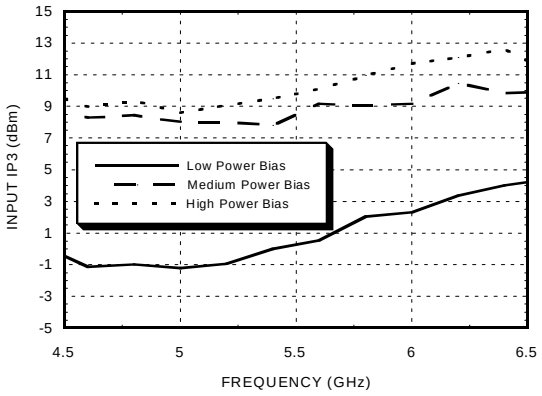
Output Return Loss @Three Bias Conditions



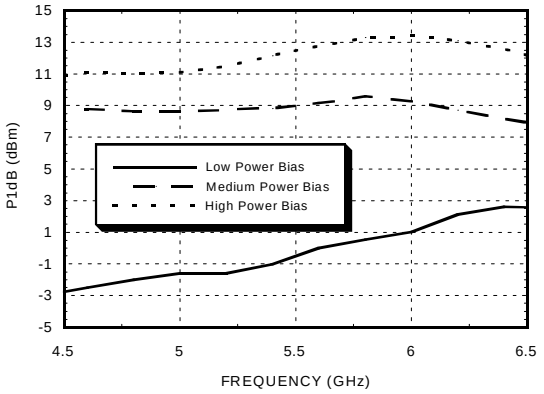
Noise Figure @ Three Bias Conditions



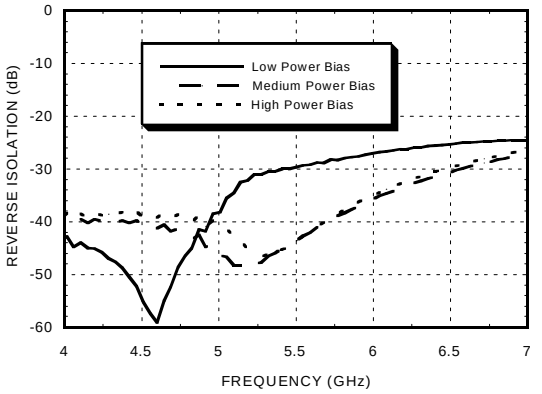
Input IP3 @Three Bias Conditions



Output 1dB Compression @ Three Bias Conditions



Reverse Isolation @ Three Bias Conditions



Adaptive Biasing

Optimizing P1dB Performance of the HMC320MS8G

The bias level may be changed to adjust the P1dB and return loss performance. The table below contains the HMC320MS8G RF performance as a function of various VSET and RBIAS settings. It will be necessary for the VSET voltage source to provide 100uA of current to the amplifier. The Idd and Vdd quiescent performance will not change as a function of changing the VSET voltage.

RF Performance at 5.8GHz (Vdd = +3v)

VSET (VDC)	RBIAS Resistor Between Pin 3 and GND (Ohms)	Idd (mA)	Output P1dB (dBm)	Output Return Loss (dB)
0	174	7	1.0	16.0
3	23	25	9.0	12.0
3	7	40	13.0	15.0
3	GND (No Resistor)	60	14.0	15.0

Applying the adaptive biasing

A dynamically controlled bias can be implemented with this design. A typical application will include sensing an RF signal level and then adjusting the VSET. The bias adjustment can be accomplished by either analog or digitals means, after the RF signal has been detected and translated to a DC voltage using external power detection circuitry.

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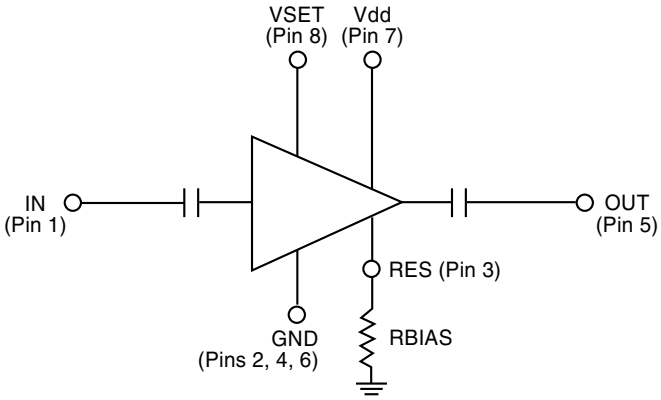
Schematic



Note: Internal DC blocks on RF I/O's are included on HMC320MS8G

Absolute Maximum Ratings

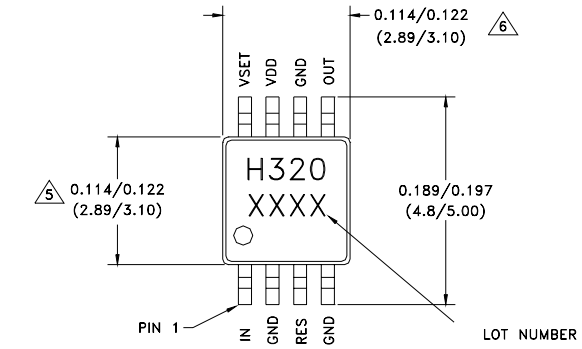
Supply Voltage (Vdd)	+7 Vdc
VSET	0V to Vdd
Input Power	+5 dBm
Channel Temperature (Tc)	175 °C
Continuous Pdiss (Ta= 85 °C) (derate 2.98 mW/°C above 85 °C)	268 mW
Storage Temperature	-65 to +150 °C
Operating Temperature	-55 to +85 °C

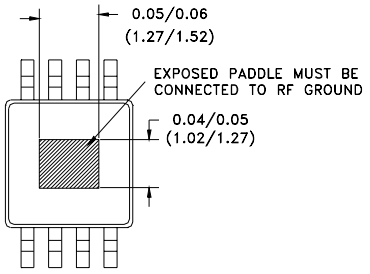
Truth Table

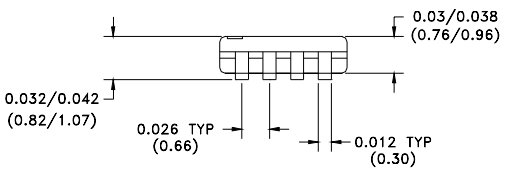
VSET	Operating Current Idd	Operating State	Resister RBIAS
0V	7 mA	Low Power	174 Ohm
3V	25 mA	Medium Power	23 Ohm
3V	40 mA	High Power	7 Ohm

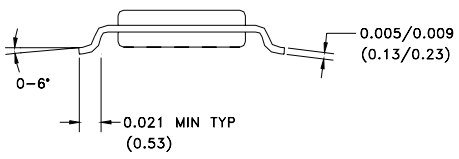
Set external bias resister (RBIAS) to achieve desired operating current 0.0< RBIAS < 200 Ω.

Outline



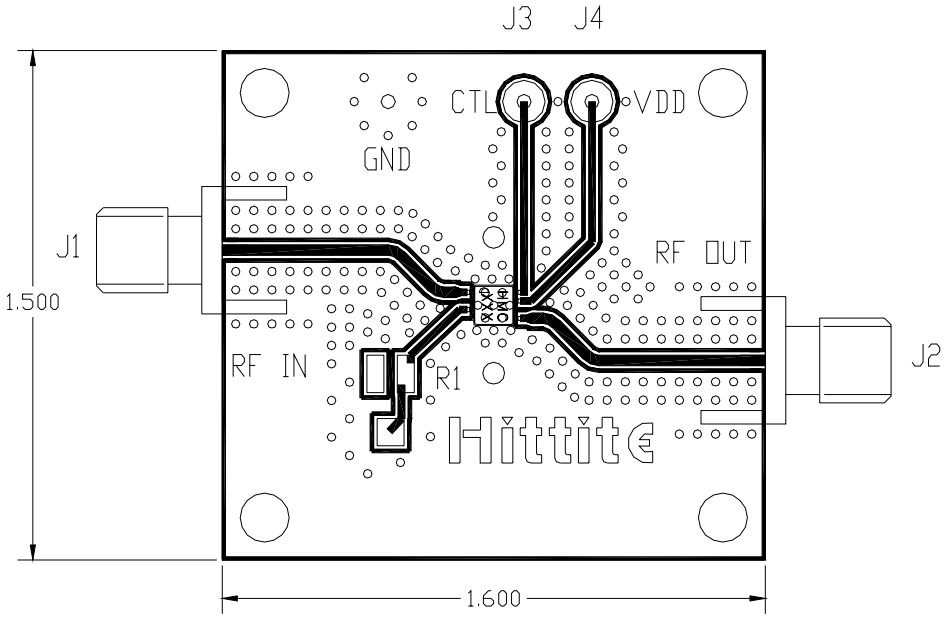






1. MATERIAL:
   A) PACKAGE BODY - LOW STRESS INJECTION-MOLDED PLASTIC, SILICA & SILICONE IMPREGNATED.
   B) LEADFRAME MATERIAL: COPPER ALLOY
2. PLATING : LEAD - TIN SOLDER PLATE
3. DIMENSIONS ARE IN INCHES (MILLIMETERS).
4. UNLESS OTHERWISE SPECIFIED ALL TOL. ARE ±0.005 (±0.13).
4. CHARACTERS TO BE HELVETICA MEDIUM, APPROX .020 HIGH WHITE INK, LOCATED APPROXIMATELY AS SHOWN.
5. DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15 MM PER SIDE
6. DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25 MM PER SIDE

Evaluation PCB for HMC320MS8G



The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown above. A sufficient number of VIA holes should be used to connect the top and bottom ground planes. The evaluation circuit board as shown is available from Hittite upon request.

Evaluation Circuit Board Layout Design Details

Item	Description
J1, J2	PC Mount SMA Connector
J3, J4	DC Pin
R1	200 Ohm Potentiometer
U1	HMC320MS8G Amplifier
PCB*	Evaluation PCB 1.6" x 1.5"
*Circuit Board Material: Rogers 4350	